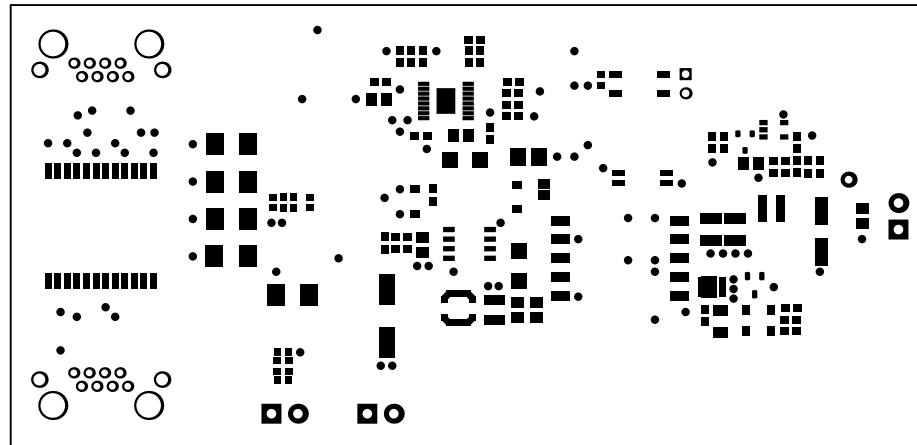
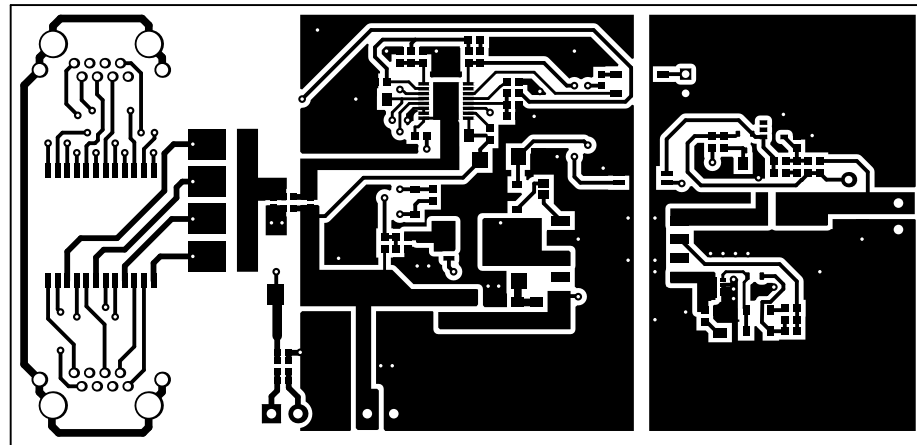


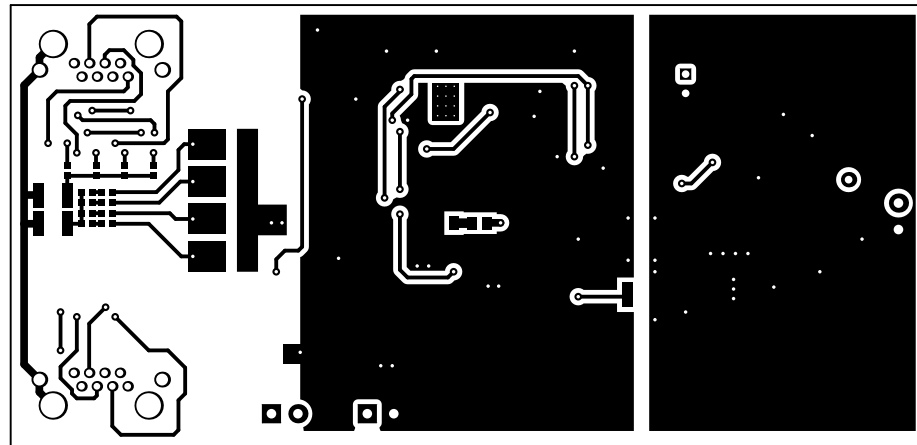
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20220	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: N/A		
PLOT NAME = Top Overlay	GENERATED : 5/22/2018 3:10:34 PM	TEXAS INSTRUMENTS	



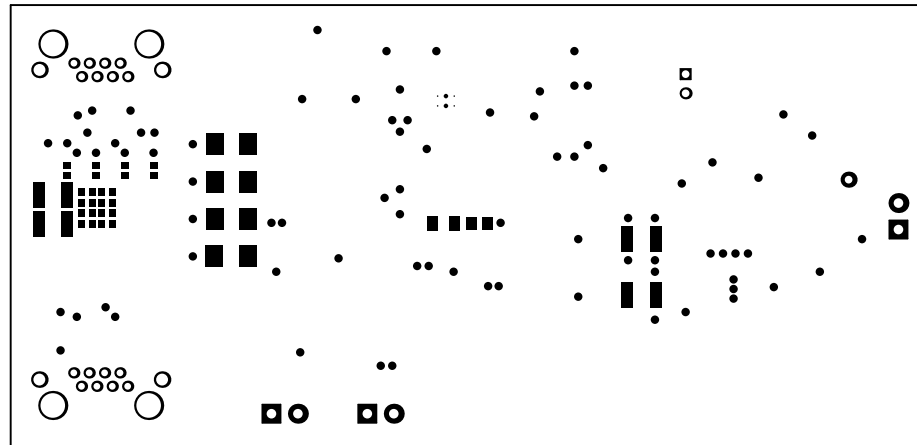
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20220	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED : 5/22/2018 3:10:35 PM	TEXAS INSTRUMENTS	



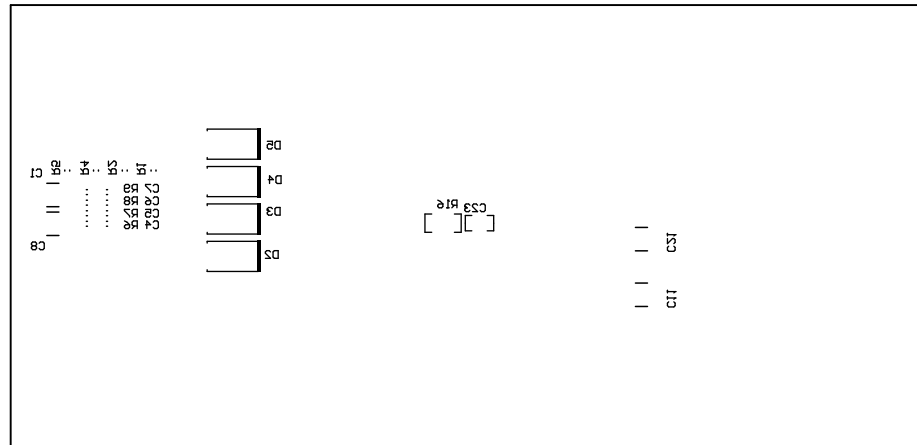
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20220	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: N/A		
PLOT NAME = Top Layer	GENERATED : 5/22/2018 3:10:35 PM	TEXAS INSTRUMENTS	



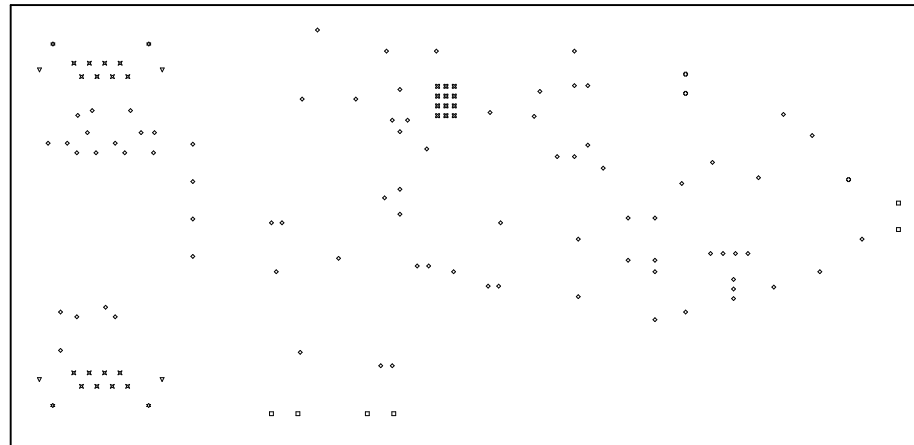
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20220	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: N/A		
PLOT NAME = Bottom Layer	GENERATED : 5/22/2018 3:10:36 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20220	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED : 5/22/2018 3:10:37 PM	TEXAS INSTRUMENTS	

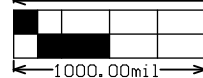
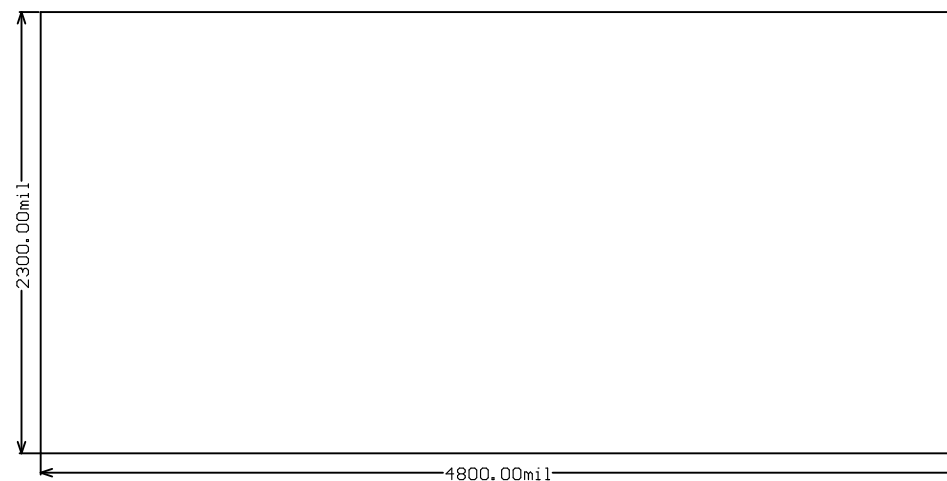


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20220	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: N/A		
PLOT NAME = Bottom Overlay	GENERATED : 5/22/2018 3:10:38 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
⊗	12	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
◇	82	18.00mil (0.457mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	16	35.04mil (0.890mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	3	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
□	6	50.00mil (1.270mm)	PTH	Round	Top Layer - Bottom Layer	
▽	4	61.81mil (1.570mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	4	128.00mil (3.251mm)	PTH	Round	Top Layer - Bottom Layer	
	127 Total					

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20220	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED : 5/22/2018	3:10:39 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20220	REV: B	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED : 5/22/2018 3:10:40 PM	TEXAS INSTRUMENTS	

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